## **DECLARATION AND POWER OF ATTORNEY**

Atty. Dkt. No.: 25611-000072/US

#### **DECLARATION**

As a below named inventor, I hereby declare that:

My residence, mailing address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

# SEMICONDUCTOR PACKAGE WITH PATTERN LEADS AND METHOD FOR MANUFACTURING THE SAME

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the specification of wh	nich (check one)			
o	s attached hereto.  vas filed on as Appli Application No a			
•	ave reviewed and understa g the claims, as amended l			
defined in 37 CFR § information which becathe national or PCT in I hereby claim foreign foreign application(s) international application States of America, lis any foreign application	aty to disclose information 1.56, including for continuous arme available between the international filing date of the priority benefits under 35 for patent or inventor's on which designated at least ted below and have also in for patent or inventor's filing date before that of	nuation-in-part applice filing date of the prious filing date of the prious continuation-in-part U.S.C. §§ 119(a)-(d) certificate, or 365(ast one country other dentified below, by cluder certificate, or any P	cations, r r applicat applicat or 365(b a) of an than the necking t CT intern	naterial ion and ion. ) of any iy PCT United he box national
	PRIOR FOREIGN APPL	ICATION(S)		
APPN. SERIAL NO.	COUNTRY	DATE FILED (MM/DD/YYYY)	PRIORITY Yes	CLAIM No
2003-7882	Korea	2/7/03	$\boxtimes$	
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### **DECLARATION AND POWER OF ATTORNEY**

I hereby claim the benefit under 35 U.S.C. § 119(e) of any United States provisional application(s) listed below:

PRIOR PROVISIONAL APPLICATION(S)		
APPN. SERIAL NO.	DATE FILED (MM/DD/YYYY)	

I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s) listed below:

	PRIOR U.S. APPLICATION(S)	
APPN. SERIAL NO.	DATE FILED (MWDD/YYYY)	STATUS - PATENTED, PENDING, ABANDONED
	·	

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

#### **POWER OF ATTORNEY**

I hereby appoint the following attorneys with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith.

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## **DECLARATION AND POWER OF ATTORNEY**

### **CORRESPONDENCE ADDRESS**

I request the Patent and Trademark Office to direct all correspondence and telephone calls relative to this application to Harness, Dickey & Pierce, P.L.C., Customer No. 30593, P.O. Box 8910, Reston, Virginia, 20195, (703) 668-8000.

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